

1. Description

JRG15T65FUA is obtained by advanced Trench Field Stop (T-FS) technology which is characteristic with low $V_{CE(sat)}$, optimized switching performance and low gate charge Q_g . The IGBT is suitable device for BLDC, UPS, and high switching frequency applications.

KEY CHARACTERISTICS

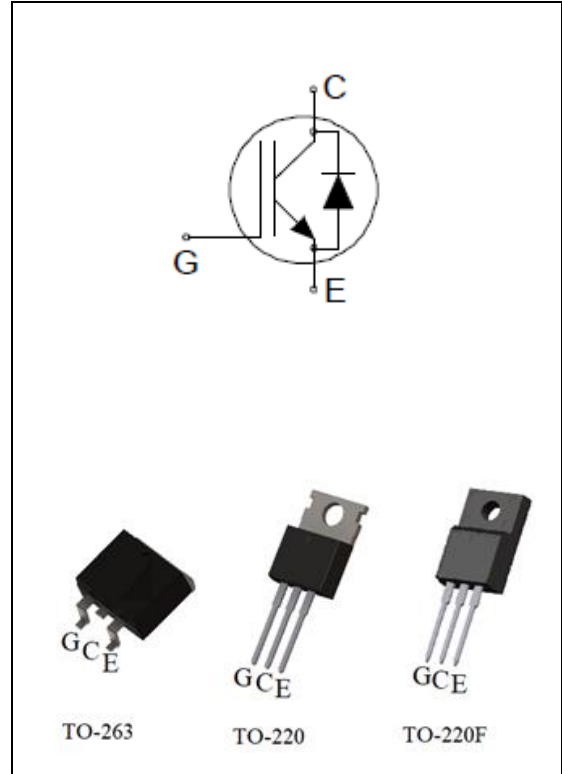
| Parameter | Value | Unit |
|-------------------|-------|------|
| V_{CES} | 650 | V |
| I_c | 15 | A |
| $V_{CE(sat).typ}$ | 1.6 | V |

FEATURES

- Fast Switching
- LOW $V_{CE(sat)}$
- Positive temperature coefficient
- Fast recovery anti-parallel diode
- RoHS product

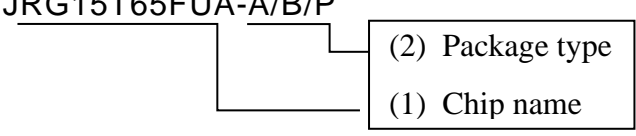
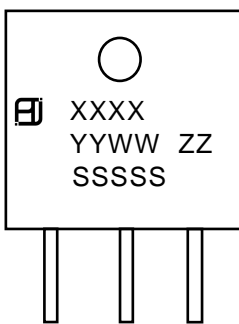
APPLICATIONS

- BLDC
- UPS
- Motor drives
- Portable power



ORDERING INFORMATION

| Ordering Codes | Package | Product Code | Packing |
|----------------|---------|--------------|---------|
| JRG15T65FUA-A | TO-220F | G1565FUA | Tube |
| JRG15T65FUA-B | TO-263 | G1565FUA | Reel |
| JRG15T65FUA-P | TO-220 | G1565FUA | Tube |

| | |
|--|---|
| <p>JRG15T65FUA-A/B/P</p>  <p>(1) JRG15T65FUA: 650V 15A (2) A:TO-220F B:TO-263 P:TO-220</p> |  <p>XXXX: Product Code YYWW: Year & Week ZZ: Assembly Code SSSS: Lot Code</p> |
|--|---|

2. ABSOLUTE RATINGS

| Symbol | Parameter | TO-220/ TO-263 | TO-220F | Units |
|---------------------|--|-------------------|----------|-------------|
| V_{CES} | Collector-Emitter Voltage | 650 | 650 | V |
| I_C | Collector Current @ $T_C=25^{\circ}C$ | 30 | 30 | A |
| | Collector Current @ $T_C=100^{\circ}C$ | 15 | 15 | A |
| I_{CM} | Pulsed Collector Current, tp limited by T_{Jmax} | 60 | 60 | A |
| I_F | Diode Continuous Forward Current @ $T_C=25^{\circ}C$ | 30 | 30 | A |
| | Diode Continuous Forward Current @ $T_C=100^{\circ}C$ | 15 | 15 | A |
| I_{FM} | Diode Maximum Forward Current, limited by T_{Jmax} | 60 | 60 | A |
| V_{GES} | Gate-Emitter Voltage | ± 30 | ± 30 | V |
| t_{SC} | Short circuit withstand time $V_{GE}=15V$, $V_{CC}\leq 400V$, Allowed number of short circuits<1000, Times between short circuits: \geq 1.0s, $T_J \leq 150^{\circ}C$ | 3.0 | | μs |
| P_D | Power Dissipation @ $T_C=25^{\circ}C$ | 78 | 28 | W |
| T_{Jmax}, T_{stg} | Operating Junction and Storage Temperature Range | 150, -55 to 150 | | $^{\circ}C$ |
| T_L | Maximum Temperature for Soldering | 260 | | $^{\circ}C$ |

3. Thermal characteristics

| Symbol | Parameter | TO-220/TO-263 | TO-220F | Units |
|-----------------|--------------------------|---------------|---------|---------------|
| $R_{\theta JC}$ | Junction-to-Case (IGBT) | 1.6 | 4.4 | $^{\circ}C/W$ |
| $R_{\theta JC}$ | Junction-to-Case (Diode) | 2.1 | 3.9 | $^{\circ}C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient | 62.5 | 78 | $^{\circ}C/W$ |

4. Electrical Characteristics

at $T_C = 25^{\circ}C$, unless otherwise specified

Static Characteristics

| Symbol | Parameter | Test Conditions | Values | | | Units |
|---------------|---|--|--------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| V_{CES} | Collector-Emitter Breakdown Voltage | $V_{GE} = 0V$, $I_C = 250\mu A$ | 650 | -- | -- | V |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $V_{GE} = 15V, I_C = 15A$ $T_J=25^{\circ}C$ | -- | 1.60 | 2.00 | V |
| | | $T_J=100^{\circ}C$ | -- | 1.80 | -- | |
| | | $T_J=150^{\circ}C$ | -- | 1.95 | -- | |



| | | | | | | |
|--|--------------------------------------|--|-----|------|------|----|
| V _{GE(TH)} | Gate Threshold Voltage | V _{CE} = V _{GE} , I _C = 1mA | 4.0 | 4.7 | 5.4 | V |
| V _F | Diode Forward Voltage | I _F =7.5A | -- | 1.40 | 2.00 | V |
| | | T _J =25°C | -- | 1.30 | -- | |
| | | T _J =100°C | -- | 1.20 | -- | |
| V _F | Diode Forward Voltage | I _F =15A | -- | 1.65 | 2.25 | V |
| | | T _J =25°C | -- | 1.60 | -- | |
| | | T _J =100°C | -- | 1.50 | -- | |
| I _{CES} | Collector-Emitter Leakage Current | V _{CE} = 650V, V _{GE} = 0V | -- | -- | 4 | μA |
| I _{GES(F)} | Gate-Emitter Forward Leakage Current | V _{GE} = +30V | -- | -- | 200 | nA |
| I _{GES(R)} | Gate-Emitter Reverse Leakage Current | V _{GE} = -30V | -- | -- | -200 | nA |
| Pulse width t _p ≤ 300μs, δ ≤ 2% | | | | | | |

Dynamic Characteristics

| Symbol | Parameter | Test Conditions | Values | | | Units |
|--------------------|--|---|--------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| C _{iss} | Input Capacitance | V _{GE} =0V V _{CE} =25V f = 1.0MHz | -- | 905 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 41 | -- | |
| C _{rss} | Reverse Transfer Capacitance | | -- | 9 | -- | |
| Q _G | Gate charge | V _{CC} =520V I _{CE} =15A V _{GE} =15V | -- | 38 | -- | nC |
| Q _{GE} | Gate-emitter charge | | -- | 12 | -- | |
| Q _{GC} | Gate-collector charge | | -- | 12 | -- | |
| I _{C(SC)} | Short circuit collector current Max.1000 short circuits, Times between short circuits: ≥ 1.0s | V _{GE} =15.0V, V _{CC} ≤400V, t _{SC} ≤3us, T _J ≤150°C | | 90 | | A |

IGBT Switching Characteristics, at T_J=25°C

| Symbol | Parameter | Test Conditions | Values | | | Units |
|---------------------|------------------------|--|--------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| t _{d(on)} | Turn-on Delay Time | I _C = 15A V _{CE} = 400V V _{GE} = 15V R _G = 10Ω T _J = 25°C Inductive Load | -- | 14 | -- | ns |
| t _r | Rise Time | | -- | 9 | -- | |
| t _{d(off)} | Turn-Off Delay Time | | -- | 67 | -- | |
| t _f | Fall Time | | -- | 61 | -- | |
| E _{on} | Turn-On Switching Loss | | | -- | 0.24 | -- |

| | | | | | | |
|-----------|-------------------------|--|----|------|----|--|
| E_{off} | Turn-Off Switching Loss | | -- | 0.28 | -- | |
| E_{ts} | Total Switching Loss | | -- | 0.52 | -- | |

IGBT Switching Characteristics, at $T_J=150^\circ\text{C}$

| Symbol | Parameter | Test Conditions | Values | | | Units |
|--------------|-------------------------|--|--------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| $t_{d(on)}$ | Turn-on Delay Time | $I_C = 15\text{A}$ $V_{CE} = 400\text{V}$ $V_{GE} = 15\text{V}$ $R_G = 10\Omega$ $T_J = 150^\circ\text{C}$ Inductive Load | -- | 13 | -- | ns |
| t_r | Rise Time | | -- | 10 | -- | |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 81 | -- | |
| t_f | Fall Time | | -- | 94 | -- | |
| E_{on} | Turn-On Switching Loss | | -- | 0.28 | -- | mJ |
| E_{off} | Turn-Off Switching Loss | | -- | 0.40 | -- | |
| E_{ts} | Total Switching Loss | | -- | 0.68 | -- | |

Diode Characteristics, at $T_J=25^\circ\text{C}$

| Symbol | Parameter | Test Conditions | Values | | | Units |
|-----------|--------------------------|--|--------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| T_{rr} | Reverse Recovery Time | $I_F = 7.5\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$ | -- | 126 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 227 | -- | nC |
| I_{rrm} | Reverse Recovery Current | | -- | 3.8 | -- | A |
| T_{rr} | Reverse Recovery Time | $I_F = 15\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$ | -- | 145 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 285 | -- | nC |
| I_{rrm} | Reverse Recovery Current | | -- | 4.0 | -- | A |

Diode Characteristics, at $T_J=150^\circ\text{C}$

| Symbol | Parameter | Test Conditions | Values | | | Units |
|-----------|--------------------------|---|--------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| T_{rr} | Reverse Recovery Time | $I_F = 7.5\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 150^\circ\text{C}$ | -- | 161 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 609 | -- | nC |
| I_{rrm} | Reverse Recovery Current | | -- | 7.0 | -- | A |
| T_{rr} | Reverse Recovery Time | $I_F = 15\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 150^\circ\text{C}$ | -- | 221 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 866 | -- | nC |
| I_{rrm} | Reverse Recovery Current | | -- | 7.8 | -- | A |



5. Characteristics Curves

Figure 1. Forward Bias Safe Operating Area for TO263/TO220

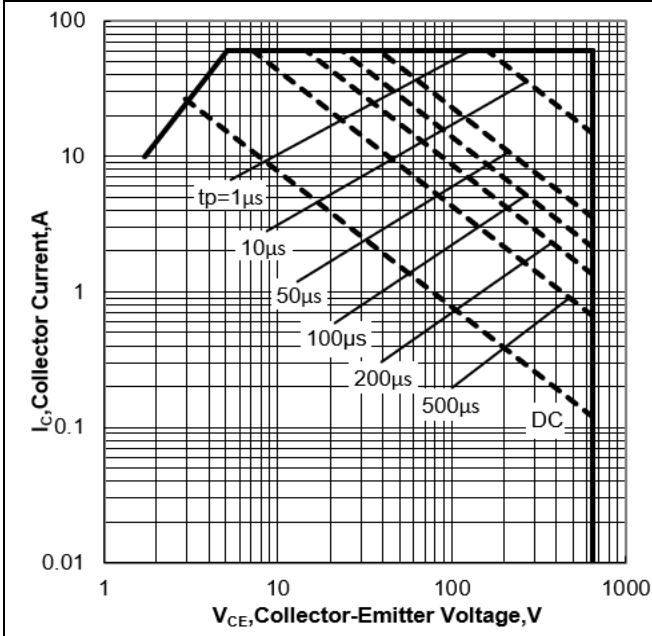


Figure 2. Forward Bias Safe Operating Area for TO220F

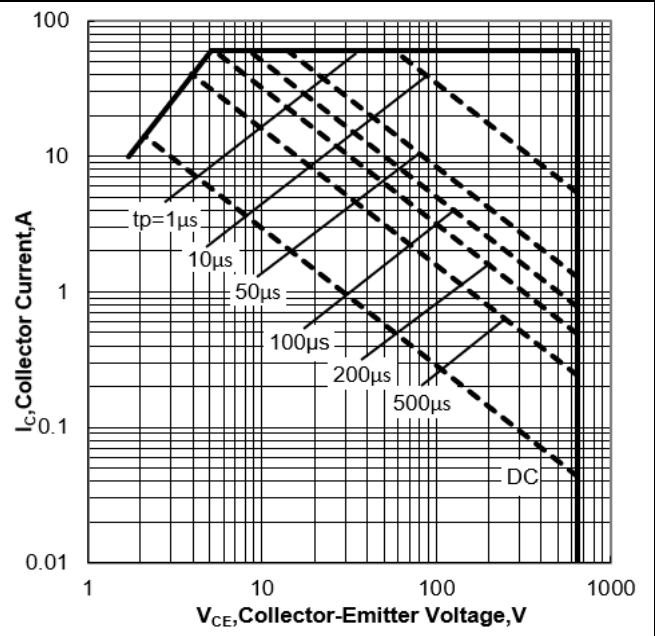


Figure 3. Power Dissipation vs Case Temperature for TO263/TO220

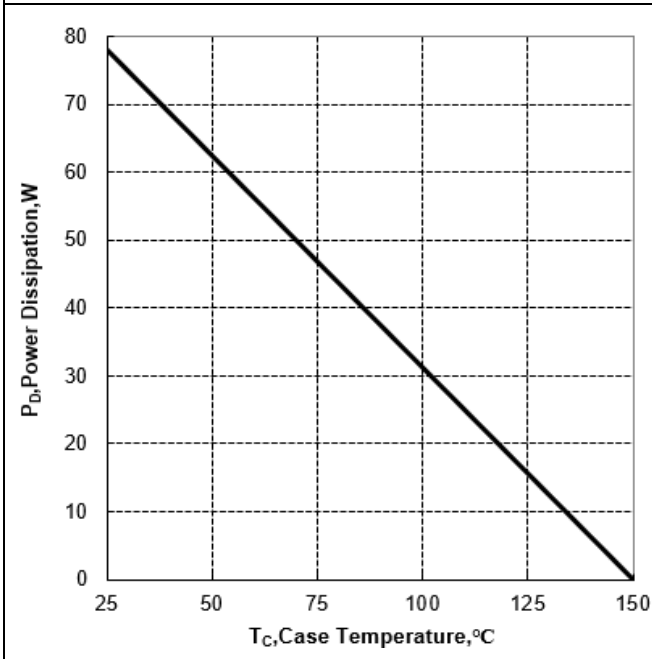


Figure 4. Power Dissipation vs Case Temperature for TO220F

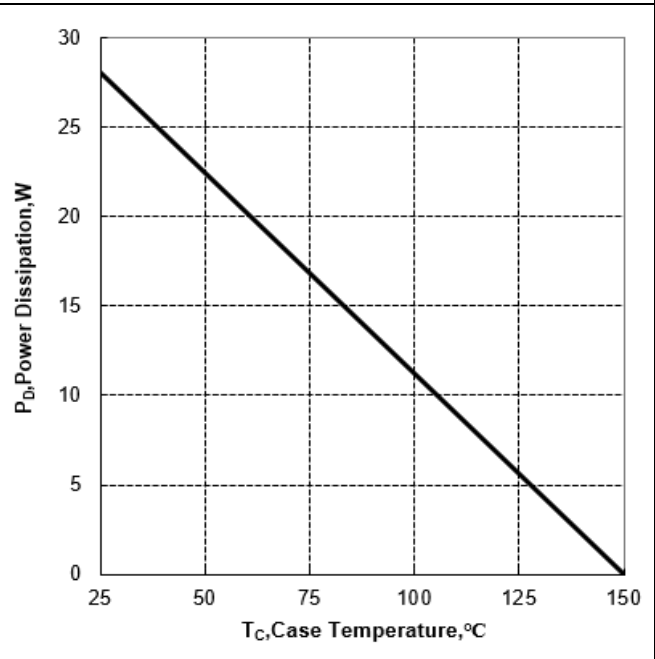




Figure 5. Collector Current vs Case Temperature

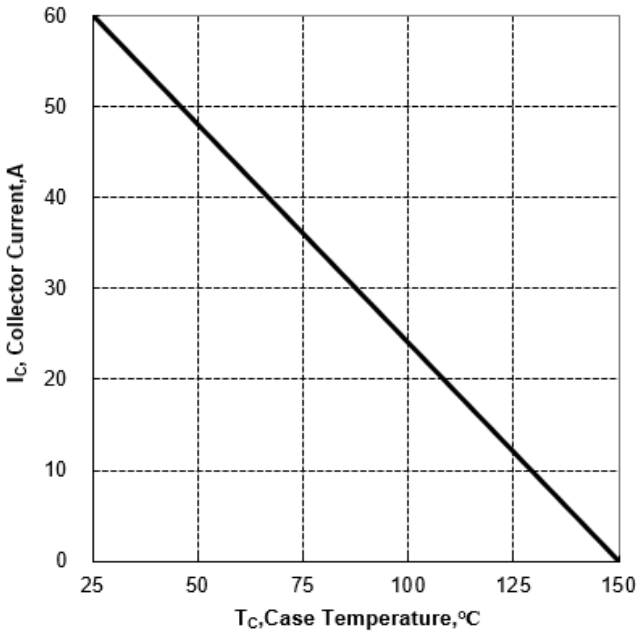


Figure 6. Typical Transfer Characteristics

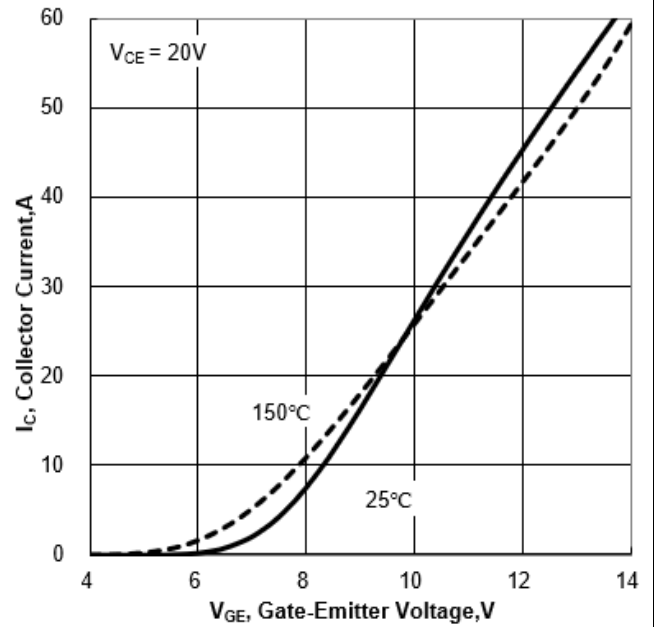


Figure 7. Output Characteristics ($T_C=25^{\circ}C$)

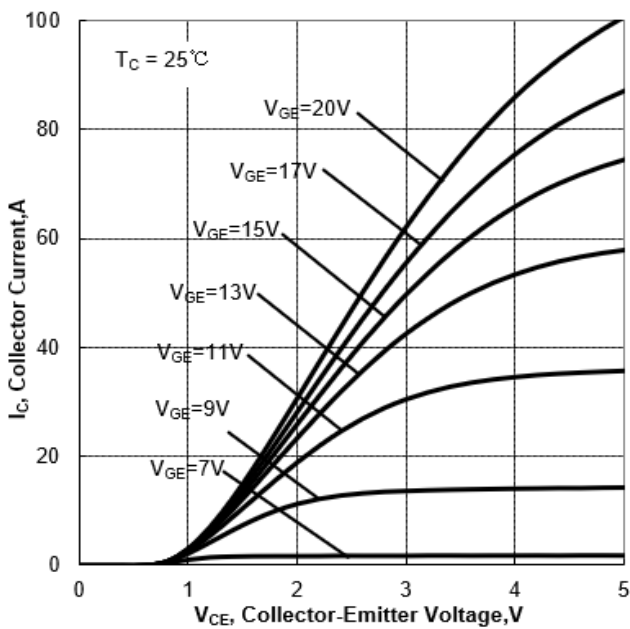


Figure 8. Output Characteristics ($T_C=150^{\circ}C$)

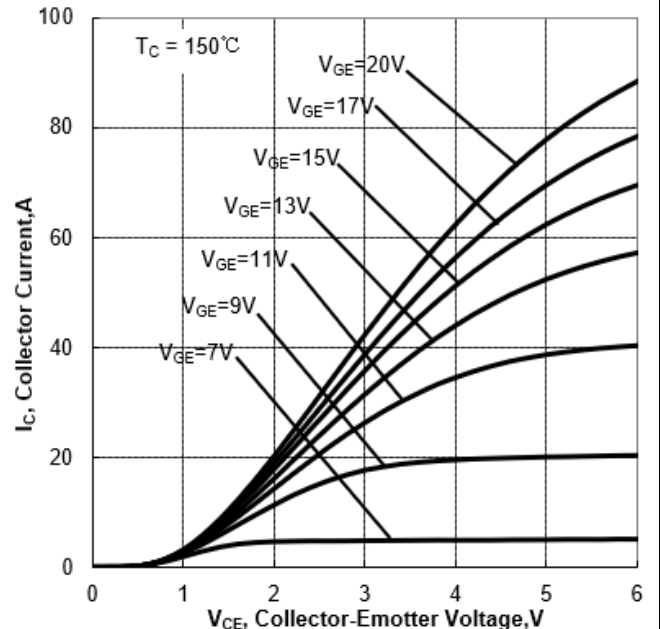




Figure 9. Gate Charge Characteristics

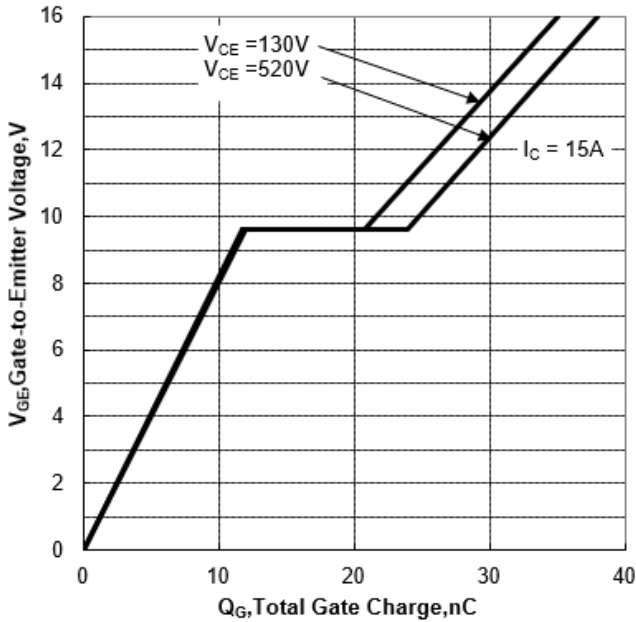


Figure 10. Typical Capacitance vs Collector-Emitter Voltage

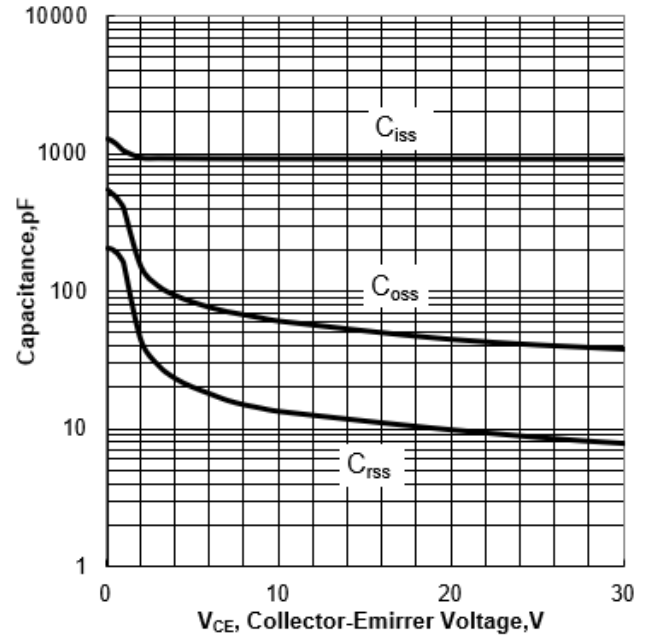


Figure 11. Collector-Emitter Saturation Voltage vs Junction Temperature ($V_{GE} = 15V$)

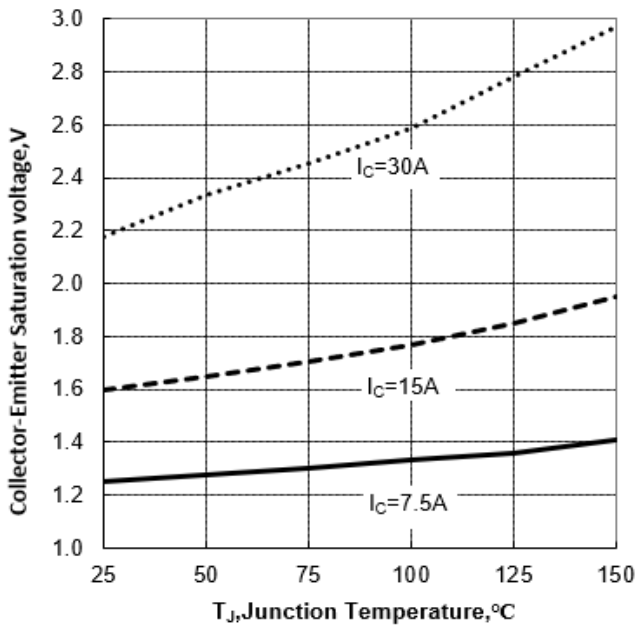


Figure 12. Threshold Voltage vs Junction Temperature ($I_C = 1mA$)

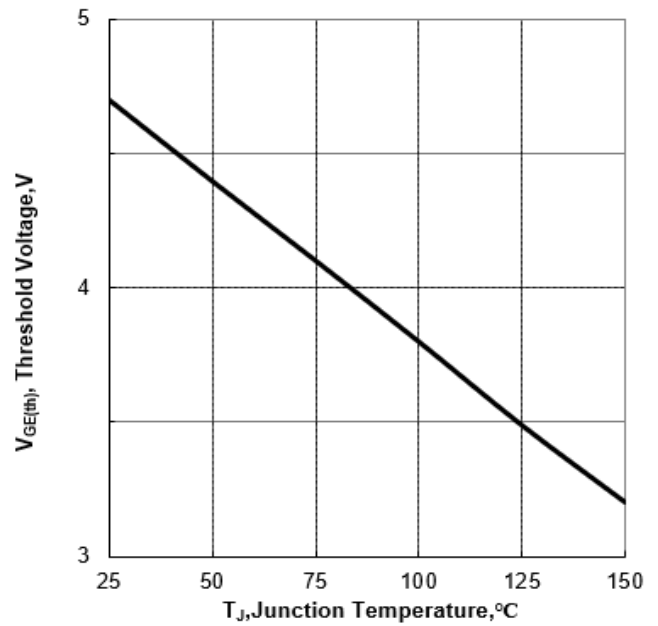




Figure 13. Typical Switching Times vs Gate Resistor($T_C=25^\circ\text{C}, V_{CE}=400\text{V}, V_{GE}=15/0\text{V}, I_C=15\text{A}$)

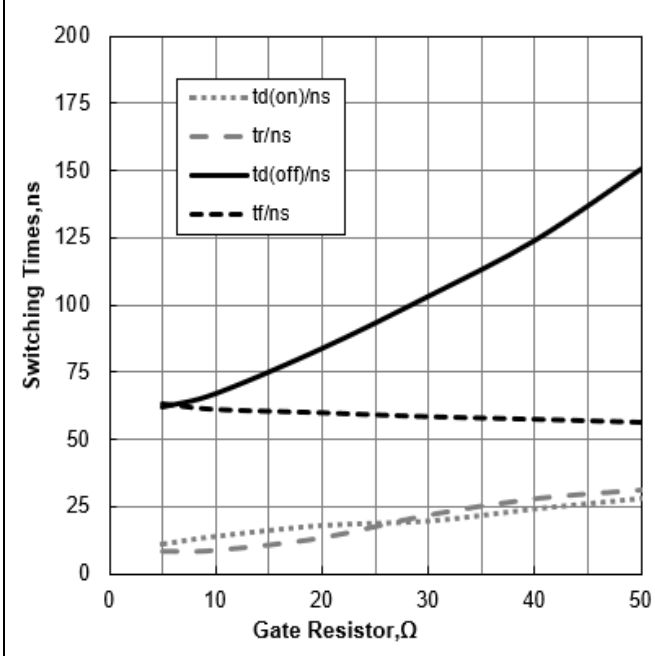


Figure 14. Typical Switching Energy vs Collector Current ($T_C=25^\circ\text{C}, V_{CE}=400\text{V}, V_{GE}=15/0\text{V}$)

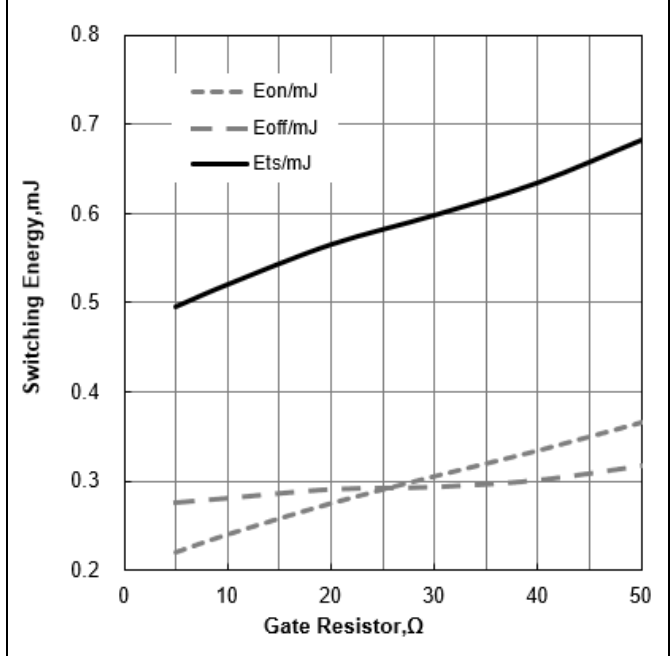


Figure 15. Typical Switching Times vs Junction Temperature($V_{CE}=400\text{V}, V_{GE}=15/0\text{V}, I_C=15\text{A}$)

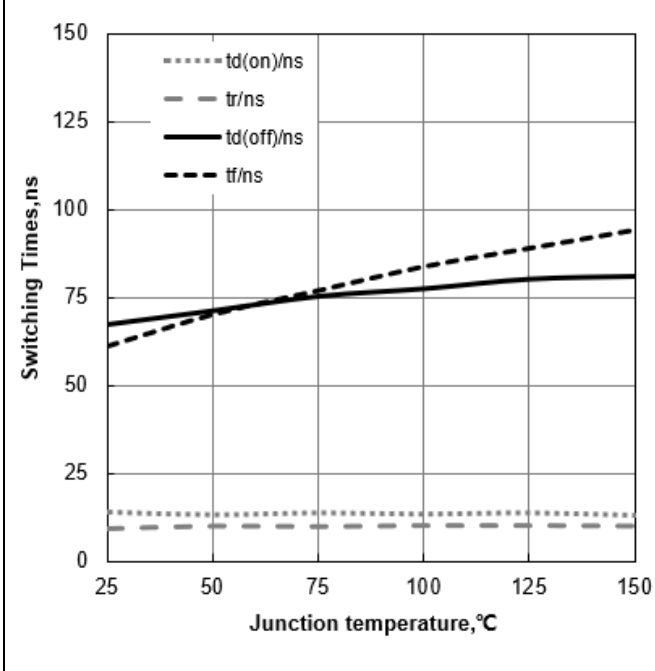


Figure 16. Typical Switching Energy vs Junction Temperature($V_{CE}=400\text{V}, V_{GE}=15/0\text{V}, I_C=15\text{A}$)

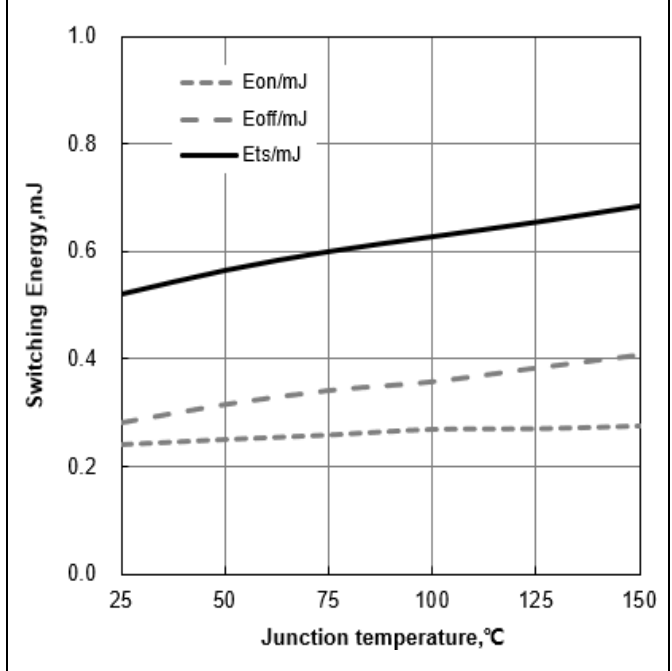




Figure 17. Typical Switching Times vs Collector Current ($T_C=25^\circ\text{C}, V_{CE}=400\text{V}, V_{GE}=15/0\text{V}$)

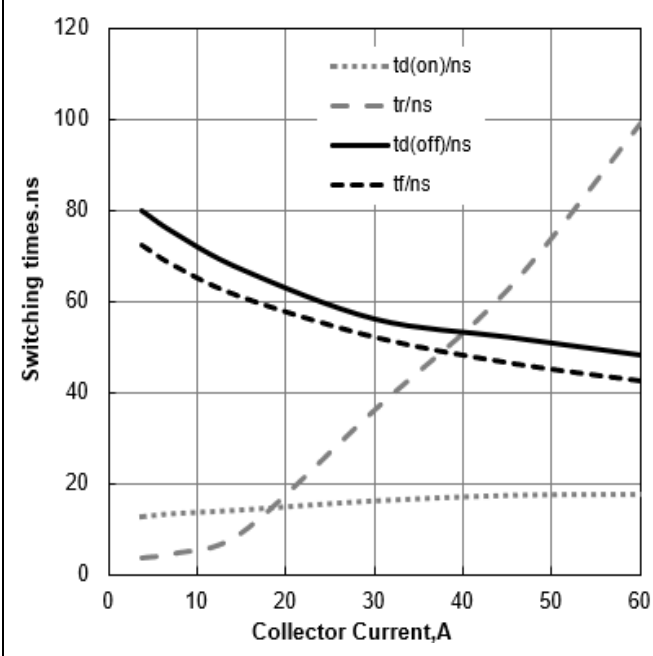


Figure 18. Typical Switching Energy vs Collector Current ($T_C=25^\circ\text{C}, V_{CE}=400\text{V}, V_{GE}=15/0\text{V}$)

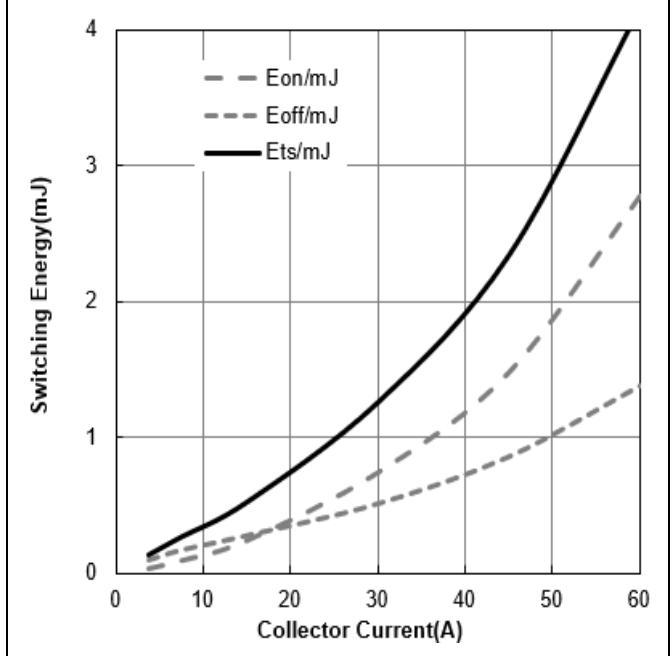


Figure 19. Typical Switching Times vs Collector Emitter Voltage ($T_C=25^\circ\text{C}, V_{GE}=15/0\text{V}, I_C=15\text{A}$)

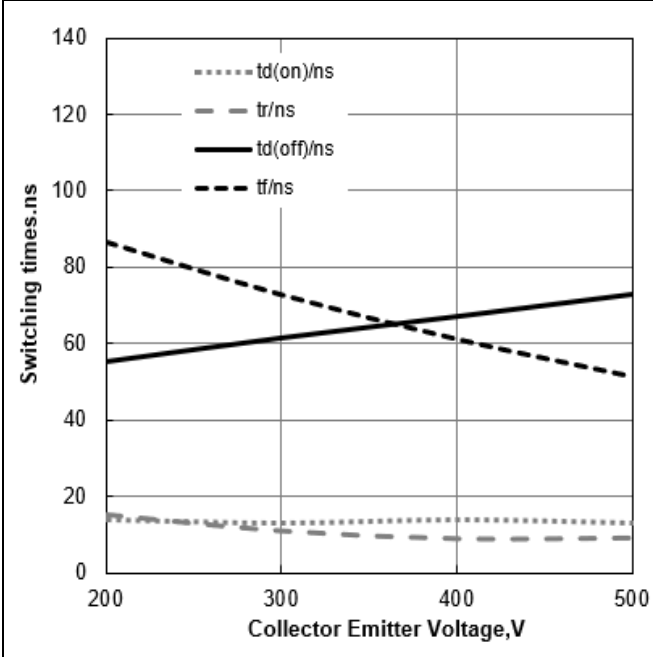


Figure 20. Typical Switching Energy vs Collector Emitter Voltage ($T_C=25^\circ\text{C}, V_{GE}=15/0\text{V}, I_C=15\text{A}$)

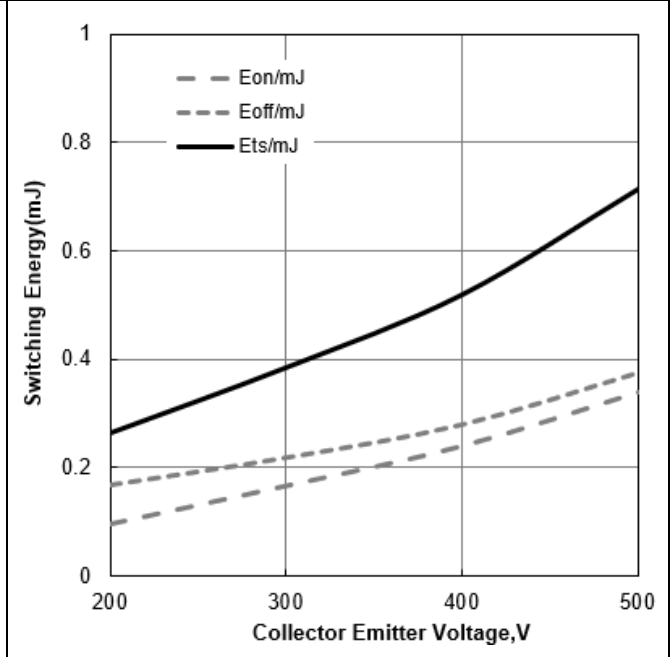




Figure 21. IGBT Transient Thermal Impedance vs Pulse Width for TO263/TO220

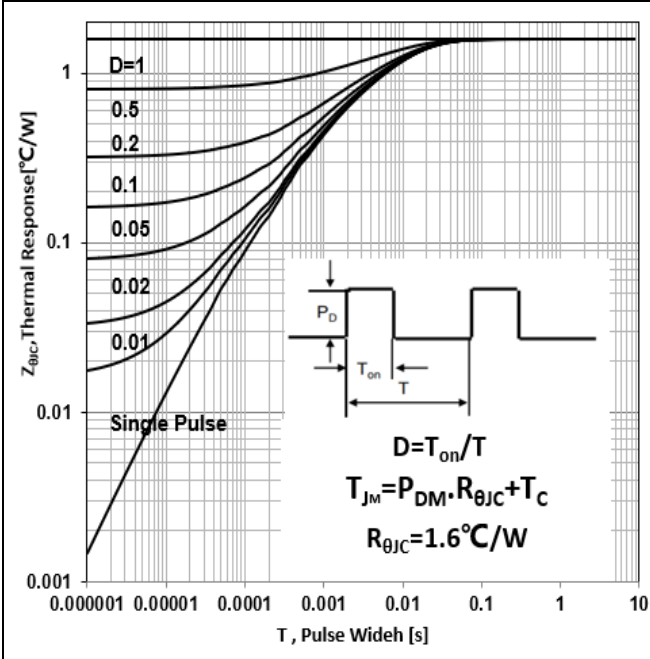


Figure 22. IGBT Transient Thermal Impedance vs Pulse Width for TO220F

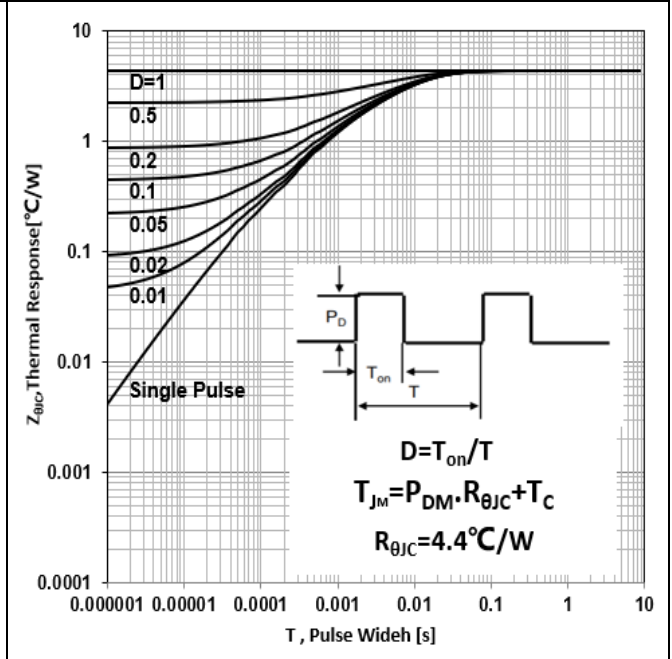


Figure 23. Diode Transient Thermal Impedance vs Pulse Width for TO263/TO220

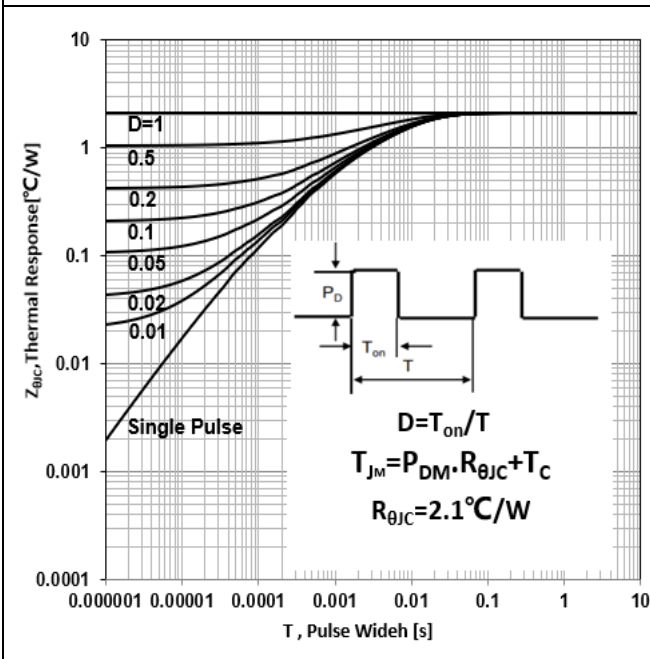


Figure 24. Diode Transient Thermal Impedance vs Pulse Width for TO220F

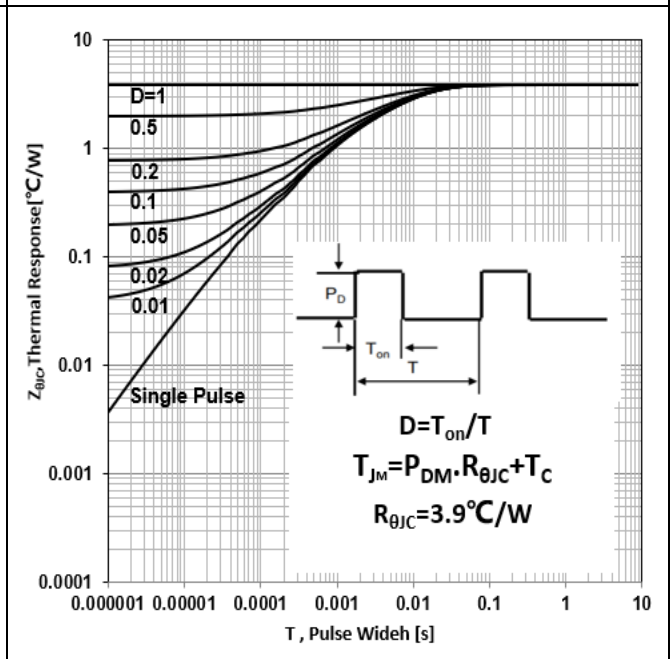
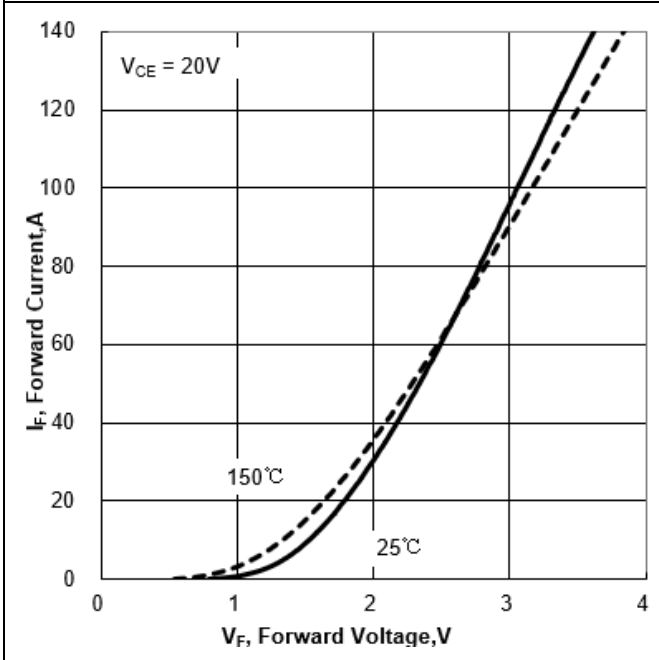
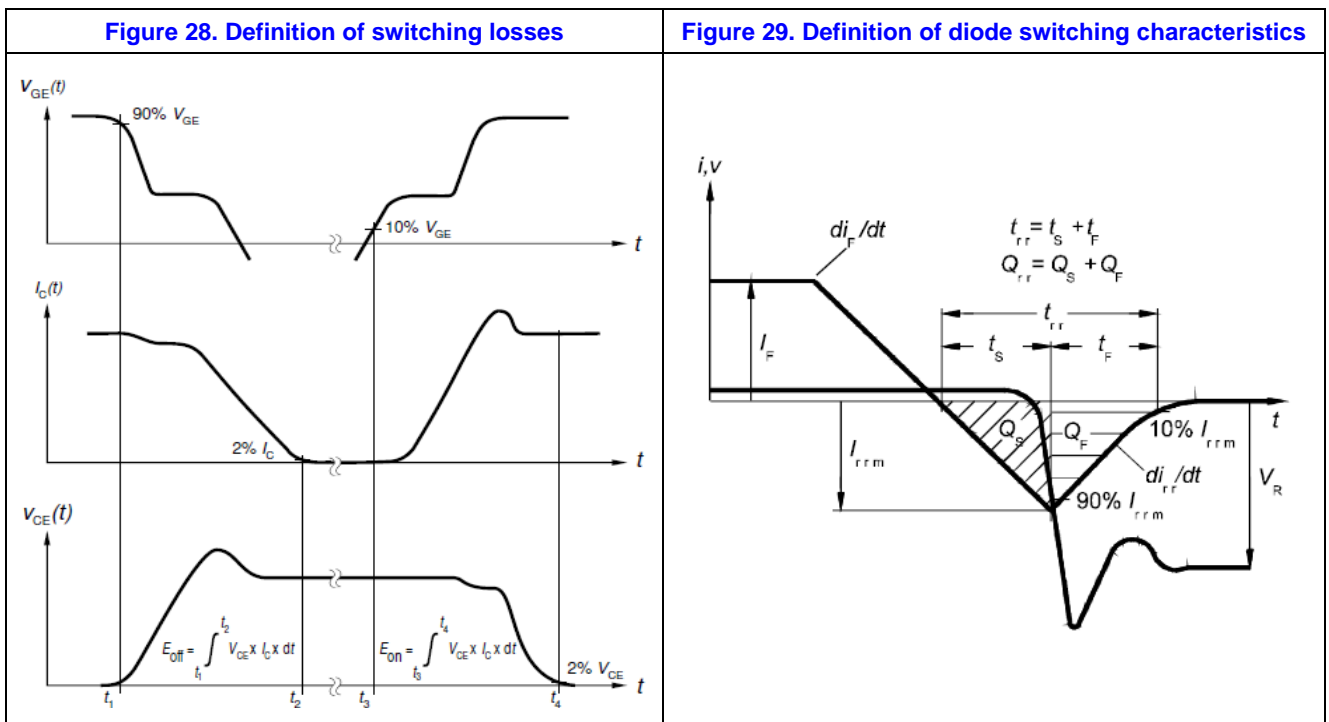
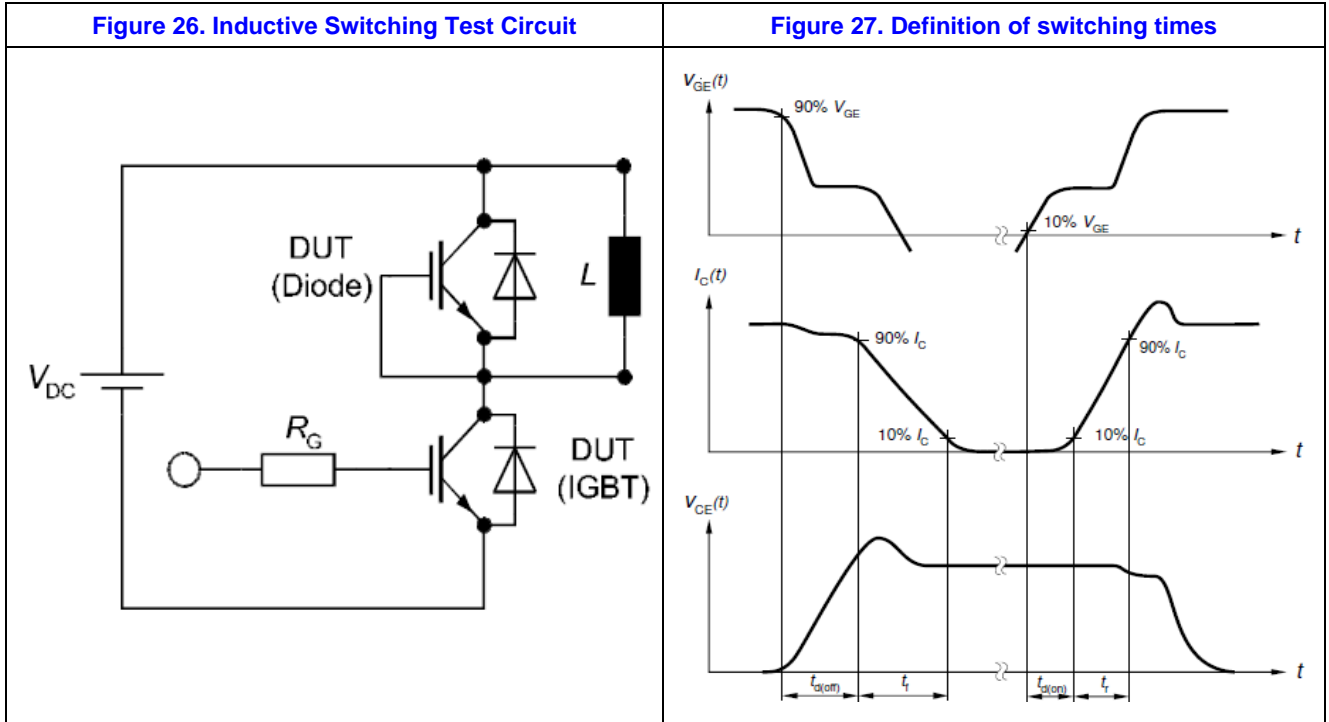




Figure 25. Typical Diode Forward Current vs Forward Voltage

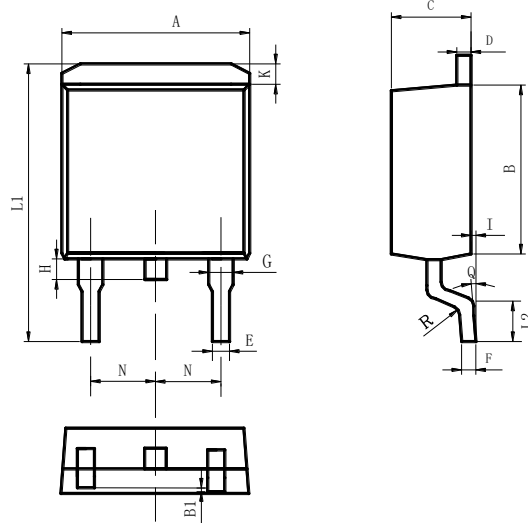


6. Test Circuit and Waveform



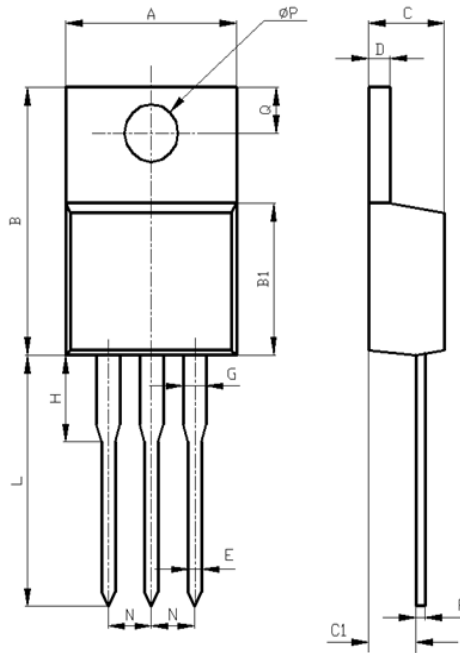


7. Package Description



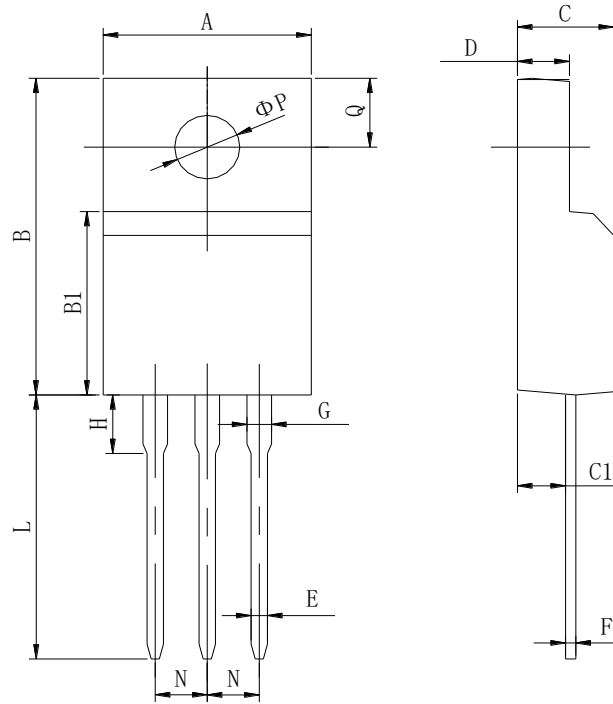
TO-263 Package

| Items | Values(mm) | |
|-------|------------|-------|
| | MIN | MAX |
| A | 9.80 | 10.40 |
| B | 8.90 | 9.50 |
| B1 | 0 | 0.10 |
| C | 4.40 | 4.80 |
| D | 1.16 | 1.37 |
| E | 0.70 | 0.95 |
| F | 0.30 | 0.60 |
| G | 1.07 | 1.47 |
| H | 1.30 | 1.80 |
| K | 0.95 | 1.37 |
| L1 | 14.50 | 16.50 |
| L2 | 1.60 | 2.30 |
| I | 0 | 0.2 |
| Q | 0° | 8° |
| R | 0.4 | |
| N | 2.39 | 2.69 |



TO-220 Package

| Items | Values(mm) | |
|----------|------------|------|
| | MIN | MAX |
| A | 9.60 | 10.6 |
| B | 15.0 | 16.0 |
| B1 | 8.90 | 9.50 |
| C | 4.30 | 4.80 |
| C1 | 2.30 | 3.10 |
| D | 1.20 | 1.40 |
| E | 0.70 | 0.90 |
| F | 0.30 | 0.60 |
| G | 1.17 | 1.37 |
| H | 2.70 | 3.80 |
| L | 12.6 | 14.8 |
| N | 2.34 | 2.74 |
| Q | 2.40 | 3.00 |
| ϕP | 3.50 | 3.90 |



TO-220F Package

| Items | Values(mm) | |
|-------|------------|------|
| | MIN | MAX |
| A | 9.60 | 10.4 |
| B | 15.4 | 16.2 |
| B1 | 8.90 | 9.50 |
| C | 4.30 | 4.90 |
| C1 | 2.10 | 3.00 |
| D | 2.40 | 3.00 |
| E | 0.60 | 1.00 |
| F | 0.30 | 0.60 |
| G | 1.12 | 1.42 |
| H | 3.40 | 3.80 |
| | 1.60 | 2.90 |
| L | 12.0 | 14.0 |
| N | 2.34 | 2.74 |
| Q | 3.15 | 3.55 |
| Φ P | 2.90 | 3.30 |



NOTE:

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. IGBTs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. Shanghai Jerrett reserves the right to make changes in this specification sheet and is subject to change without prior notice.